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"CARBON DOPING OF COMPOUND SEMICONDUCTOR EPITAXIAL LAYERS USING CARBON TETRACHLORIDE"

FINAL REPORT

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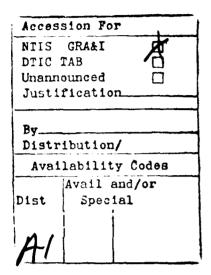
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bipolar transistor (HBT). HBTs with 3 x 10 $\,$ m self-aligned emitter fingers have been fabricated which exhibit a current gain cutoff frequency of f_t = 26 GHz,





Final Report

Heavily doped p-type layers in GaAs and Al_xGa_{1-x}As are commonly used in several device structures. They are important in diode lasers and in the base region of heterojunction bipolar transistors (HBTs). Magnesium and Zn are commonly used p-type dopants in metalorganic chemical vapor deposition (MOCVD), but these dopants exhibit problems in obtaining abrupt doping profiles due to the adsorbtion of these reactants on the internal surfaces of the growth chamber and gas lines. In addition, rapid diffusion of group IIA and IIB elements in GaAs can also lead to dopant redistribution during growth and subsequent processing.

Carbon has been proposed as an alternative dopant to Mg and Zn. Carbon is expected to incorporate only as a shallow acceptor on an As site with very little intersutial incorporation, even at high doping levels. As a result, carbon is expected to have greatly improved diffusion characteristics in comparison to Mg and Zn.

High carbon concentrations have been obtained in GaAs grown by several techniques. High carbon acceptor concentrations have been achieved in GaAs grown by molecular beam epitaxy (MBE) using carbon evaporated from a heated graphite source. Carbon incorporation from trimethylgallium (TMGa), a common Ga growth precursor, has been used to obtain high carbon concentrations in GaAs grown by atomic layer epitaxy (ALE) and metalorganic molecular beam epitaxy (MOMBE).

Several methods for carbon doping have also been proposed for the MOCVD growth technique. Intentional addition of carbon using a number of hydrocarbon sources has not been successful, or has led to films of low carbon content. One researcher has successfully added carbon to GaAs layers with trimethylarsenic. In this work, CCl4 is used to controllably obtain p-type GaAs and Al_xGa_{1-x}As with carrier concentrations between $1 \times 10^{16} \text{ cm}^{-3}$ and $1 \times 10^{19} \text{ cm}^{-3}$ in low pressure MOCVD-grown layers. In

addition, CCl4 doping yields excellent doping abruptness and does not display the memory effects apparent with Mg and Zn doping.

First, a mixture of 500 ppm CCl4 in H₂ was used to grow heavily doped p-type GaAs by low pressure MOCVD with TMGa and AsH₃ as the group III and V sources, respectively. Carbon acceptor concentrations between 1x10¹⁶cm⁻³ and 1x10¹⁹cm⁻³ were obtained. In addition, abrupt carbon doping profiles were achieved with no noticeable memory effects. Carrier concentration was studied as a function of CCl4 flow, V/III ratio, growth temperature, and growth rate using electrochemical capacitance-voltage profiling. Carbon incorporation was found to depend upon CCl4 flow, V/III ratio, and growth temperature.

Next, to understand the effect of growth parameters on carbon incorporation in CCl4 doped $Al_xGa_{1-x}As$, carbon acceptor concentration was studied as a function of Al composition, growth temperature, growth rate, and CCl4 flow rate using electrochemical capacitance-voltage profiling. The carbon incorporation as a function of Al composition, growth temperature and CCl4 flow rate was also measured by secondary ion mass spectroscopy (SIMS). All layers were grown by low pressure MOCVD using TMGa and TMAl as column III precursors, and 100% AsH3 as the column V source. Increased Al composition reduced the dependence of carbon concentration on the growth temperature. Reduced growth rate, which resulted in substantially decreased carbon acceptor concentrations in GaAs, had an insignificant effect on the carrier concentration of $Al_{0.4}Ga_{0.6}As$. A linear relationship between hole concentration and CCl4 flow rate in $Al_xGa_{1-x}As$ for $0.0 \le x \le 0.8$ was observed. These results indicate that adsorption and desorption of CCl4 on the $Al_xGa_{1-x}As$ surface during crystal growth plays an important role in the carbon incorporation mechanism.

Intentional carbon doping of low pressure MOCVD grown InP was attempted with a 500 ppm mixture of 13 CCl₄ in high purity H₂, which was used to obtain carbon acceptor concentrations as high as 1 x 10 cm⁻³ in GaAs. Under growth conditions similar to

those used for heavy carbon incorporation in GaAs, injection of ¹³CCl₄ into the growth reactor during growth of InP did not produce any measurable change in the carrier concentration of the InP epitaxial layers or any change in the ¹³C concentration above the ¹³C background in SIMS analysis. These results support previous low temperature photoluminescence (PL) measurements of high purity InP in which no residual carbon acceptor is observed regardless of the growth technique or conditions, and the hypothesis that carbon is not incorporated in InP grown by any epitaxial technique.

The effects of background doping, surface encapsulation, and arsenic vapor pressure on the diffusion rate of carbon in GaAs were studied by performing anneals on 1000 Å carbon-doped spikes of GaAs grown within 1 µm layers of undoped, Mg doped, and Se doped GaAs. The layers were grown by low pressure MOCVD, and CCl4 was used as the carbon doping source for the doping spikes. The As4 vapor pressure during annealing was controlled by the addition of elemental As to the sealed quartz ampoule used for the diffusion. For each As4 overpressure, two samples, one Si3N4-capped, and one capless were annealed together. All anneals were performed at 825°C for 24 hours. SIMS was used to measure the variation of the carbon concentration as a function of depth for both the as-grown and the annealed samples. The diffusion rate of carbon is found to depend strongly upon the species used for the background doping, being highest in Mg-doped GaAs, and lowest in Se-doped GaAs. The type of surface encapsulation and the As vapor pressure are found to have a very minor effect on the carbon diffusion rate.

Finally, CCl₄ was used as a carbon doping source for the base region of a GaAs/AlGaAs Npn heterojunction bipolar transistor (HBT) grown by low pressure MOCVD. Transistors were fabricated and characterized for dc current gain, emitter-base junction ideality factor, base contact resistance, and external base resistance. Microwave characterization by S-parameter measurement was performed to determine the common emitter current gain and maximum available gain as a function of frequency. Transistors with the base contact area self-aligned to a 3 x 10 µm emitter finger had a dc current gain

as high 50, an emitter-base junction ideality factor of n=1.2, and a current gain cutoff frequency of $f_t=26$ GHz. Transistors of equal emitter area without self-alignment exhibited dc current gain as high as 86, n=1.2, and $f_t=20$ GHz. A base contact resistance of $R_c=2.85 \times 10^{-6} \, \Omega \, \mathrm{cm^2}$, and an external base sheet resistance of $R_s=533.4 \, \Omega/\mathrm{square}$ were measured. These preliminary results indicate that carbon doping from CCl4 may be an attractive substitute for Zn or Mg in GaAs/AlGaAs HBT structures grown by MOCVD.